PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KUEI-YI CHUANG	07/02/2015
FENG-PO TSENG	07/01/2015
KUO-CHAN CHIOU	07/01/2015
LU-SHIH LIAO	07/01/2015

RECEIVING PARTY DATA

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State/Country:	TAIWAN
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14805094

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NAME OF SUBMITTER:	CHRISTOPHER SMITH
SIGNATURE:	/Christopher Smith/
DATE SIGNED:	07/22/2015

Total Attachments: 2
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ASSIGNMENT

WHEREAS, Kuei-Yi CHUANG, Feng-Po TSENG, Kuo-Chan CHIOU and Lu-Shih LIAO hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: Resin formulations, resin polymers and composite materials comprising the resin polymers

Filed: July 21, 2015 Serial No. 14/805,094

Executed on: July 2, 2015; July 1, 2015; July 1, 2015 and July 1, 2015

WHEREAS, Industrial Technology Research Institute of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 31040, Taiwan, R. O. C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Full name of sole or first inventor: Kuei-Yi CHUANG	
Inventor's signature: Kuei-Yi CHUANG	Date: 2015/7/1

Full name of second inventor: Feng-Po TSENG	
Inventor's signature: Feng-Po Tseng	Date: 2015/7/1

P54030016US; 0954-A24618-US

Full name of third inventor: Kuo-Chan CHIOU	
Inventor's signature:	Date: 2015.7.1

Full name of fourth inventor: Lu-Shih LIAO	
Inventor's signature: Lu-Shih Liao	Date: 2015/7/1